502240751 02/22/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hideki AYANO	11/23/2012
Katsumi ISHIKAWA	11/08/2012
Kazutoshi OGAWA	11/08/2012
Tsutomu KOMINAMI	11/12/2012
Mami KUNIHIRO	11/08/2012

RECEIVING PARTY DATA

Name:	Hitachi, Ltd.	
Street Address:	6-6, Marunouchi 1-chome	
City:	Chiyoda-ku, Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13806822

CORRESPONDENCE DATA

Fax Number: 2026288844

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

2026242500 Phone:

Galemousavi@crowell.com Email: Correspondent Name: Crowell & Moring LLP Address Line 1: P.O. Box 14300

Address Line 4: Washington, DISTRICT OF COLUMBIA 20044-4300

ATTORNEY DOCKET NUMBER:	056208.65192US
NAME OF SUBMITTER:	Michael H. Jacobs

Total Attachments: 1

source=65192US_ASSIGNMENT#page1.tif

502240751

REEL: 029861 FRAME: 0904

Attorney Docket Number: 056208.65192US

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

POWER CONVERSION DEVICE AND TEMPERATURE RISE CALCULATION METHOD THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Hideki AYANO	Holeki Ayam	11/23/20/2
2) Katsumi ISHIKAWA	Idatsumi Ishikawa	11/8/20/2
3) <u>Kazutoshi OGAWA</u>	Kajutoshi Ogawa	H/P/20/2
4) Tsutomu KOMINAMI	Tautoun Kominand	11/12/2012
5) Mami KUNIHIRO	Tantoin Kominand Mami Kunihiro	11/8/2012
6)		
7)		
8)		
9)		
0)		

PATENT REEL: 029861 FRAME: 0905

RECORDED: 02/22/2013